



Attorney's Docket No.: 07977/046002, 08041/3050/3059/3063D1

#21/A  
9/8/02  
12/1/02  
12/1/02  
12/1/02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Shunpei Yamazaki, et al. Art Unit : 1765  
Serial No.: 09/304,523 Examiner : Robert Kunemund  
Filed : May 4, 1999  
Title : METHOD AND APPARATUS FOR PRODUCING SEMICONDUCTOR  
DEVICE

BOX AF

Commissioner for Patents  
Washington, D.C. 20231

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AMENDMENT

Sir:

In response to the Official Action dated December 10, 2001,  
Paper No. 19, in the above-referenced application, kindly amend  
the above-identified application as follows.

In the Claims:

Please amend the claims as follows.

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A. 7. (Amended) A method of manufacturing a semiconductor  
device comprising the steps of:  
forming a semiconductor film over an upper surface of a  
substrate;

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